

National Semiconductor

DS90C383/DS90CF384

+3.3V Programmable LVDS Transmitter 24-Bit Flat Panel Display (FPD) Link—65 MHz, +3.3V LVDS Receiver 24-Bit Flat Panel Display (FPD) Link-65 MHz

General Description

The DS90C383 transmitter converts 28 bits of CMOS/TTL data into four LVDS (Low Voltage Differential Signaling) data streams. A phase-locked transmit clock is transmitted in parallel with the data streams over a fifth LVDS link. Every cycle of the transmit clock 28 bits of input data are sampled and transmitted. The DS90CF384 receiver converts the LVDS data streams back into 28 bits of CMOS/TTL data. At a transmit clock frequency of 65 MHz, 24 bits of RGB data and 3 bits of LCD timing and control data (FPLINE, FPFRAME, DRDY) are transmitted at a rate of 455 Mbps per LVDS data channel. Using a 65 MHz clock, the data throughputs is 227 Mbytes/sec. The transmitter is offered with programmable edge data strobes for convenient interface with a variety of graphics controllers. The transmitter can be programmed for Rising edge strobe or Falling edge strobe through a dedicated pin. A Rising edge transmitter will inter-operate with a Falling edge receiver (DS90CF384) without any translation logic. The DS90CF384 is also offered in 64 ball, 0.8mm fine pitch ball grid array(FBGA) package which provides a 44 % reduction in PCB footprint (available Q3, 1999).

This chipset is an ideal means to solve EMI and cable size problems associated with wide, high speed TTL interfaces.

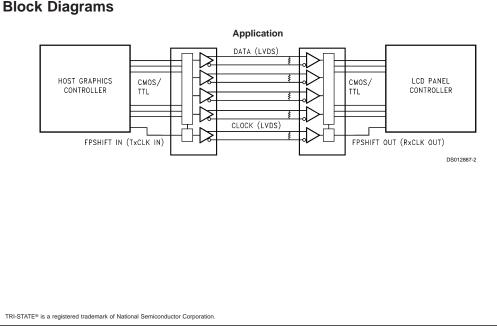
Features

- 20 to 65 MHz shift clock support
- Programmable transmitter (DS90C383) strobe select (Rising or Falling edge strobe)

September 1999

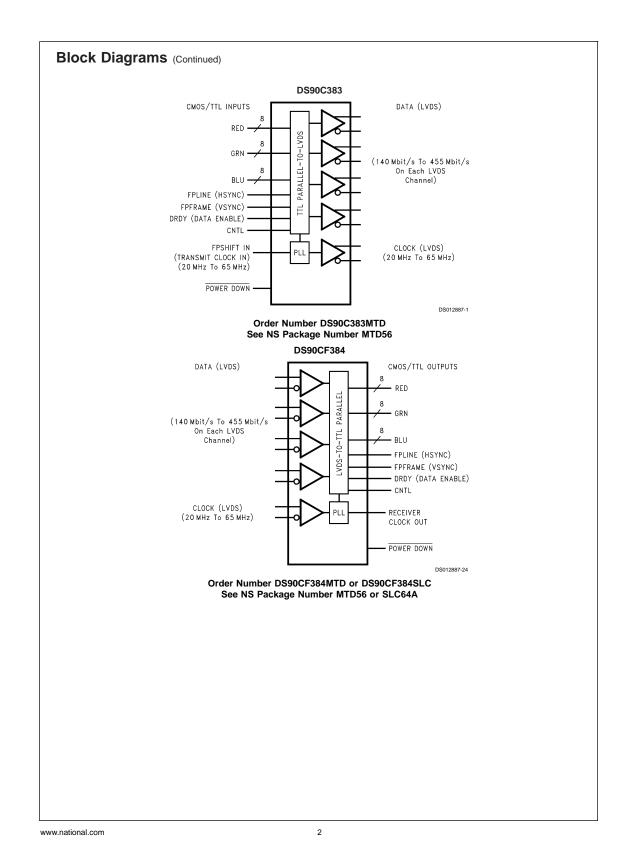
ink— 65 MHz

- Single 3.3V supply
- Chipset (Tx + Rx) power consumption < 250 mW (typ)
- Power-down mode (< 0.5 mW total)</p>
- Single pixel per clock XGA (1024x768) ready
- Supports VGA, SVGA, XGA and higher addressability.
- Up to 227 Megabytes/sec bandwidth
- Up to 1.8 Gbps throughput
- Narrow bus reduces cable size and cost
- 290 mV swing LVDS devices for low EMI
- PLL requires no external components
- Low profile 56-lead TSSOP package.
- DS90CF384 also available in 64 ball, 0.8mm fine pitch ball grid array(FBGA) package
- Falling edge data strobe Receiver
- Compatible with TIA/EIA-644 LVDS standard
- ESD rating >7 kV
- Operating Temperature: -40°C to +85°C



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DS90C383/DS90CF384 +3.3V Programmable LVDS 24-Bit-Color Flat Panel Display (FPD)



Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Supply Voltage (V _{CC})	-0.3V to +4V
CMOS/TTL Input Voltage	-0.3V to (V _{CC} + 0.3V)
CMOS/TTL Output Voltage	-0.3V to (V _{CC} + 0.3V)
LVDS Receiver Input Voltage	-0.3V to (V _{CC} + 0.3V)
LVDS Driver Output Voltage	-0.3V to (V _{CC} + 0.3V)
LVDS Output Short Circuit Duration	Continuous
Junction Temperature	+150°C
Storage Temperature	-65°C to +150°C
Lead Temperature (Soldering, 4 sec for TSSOP)	+260°C
Solder Reflow Temperature (20 sec for FBGA)	+220°C
Maximum Package Power Dissipat	ion Capacity 25°C
MTD56 (TSSOP) Package:	
DS90C383MTD	1.63 W
DS90CF384MTD	1.61 W
Package Derating:	

DS90C383MTD	12.5 mW/°C above +25°C
DS90CF384MTD	12.4 mW/°C above +25°C
Maximum Package Power D	issipation Capacity 25°C
SLC64A Package:	
DS90CF384SLC	2.0 W
Package Derating:	
DS90CF384SLC	10.2 mW/°C above +25°C
ESD Rating	
(HBM, 1.5 kΩ, 100 pF)	> 7 kV

Recommended Operating Conditions

	Min	Nom	Max	Units
Supply Voltage (V _{CC})	3.0	3.3	3.6	V
Operating Free Air				
Temperature (T _A)	-40	+25	+85	°C
Receiver Input Range	0		2.4	V
Supply Noise Voltage (V _{CC})			100	mV _{PP}

Electrical Characteristics

Over recommended operating supply and temperature ranges unless otherwise specified.

ymbol	Parameter	Conditio	ons	Min	Тур	Max	Units
CMOS/T	TL DC SPECIFICATIONS			•			
V _{IH}	High Level Input Voltage			2.0		V _{cc}	V
V _{IL}	Low Level Input Voltage			GND		0.8	V
V _{он}	High Level Output Voltage	I _{OH} = -0.4 mA		2.7	3.3		V
V _{ol}	Low Level Output Voltage	I _{OL} = 2 mA			0.06	0.3	V
V _{CL}	Input Clamp Voltage	I _{CL} = -18 mA			-0.79	-1.5	V
IN	Input Current	$V_{IN} = V_{CC}, \text{ GND}, 2.5V$	or 0.4V		±5.1	±10	μA
os	Output Short Circuit Current	V _{OUT} = 0V			-60	-120	mA
LVDS D	C SPECIFICATIONS						
V _{OD}	Differential Output Voltage	$R_L = 100\Omega$		250	345	450	mV
ΔV _{od}	Change in V _{OD} between					35	mV
	complimentary output states						
V _{os}	Offset Voltage (Note 4)			1.125	1.25	1.375	V
۵۷ _{os}	Change in V _{OS} between					35	mV
	complimentary output states						
los	Output Short Circuit Current	$V_{OUT} = 0V, R_L = 100\Omega$			-3.5	-5	mA
oz	Output TRI-STATE® Current	Power Down = 0V,			±1	±10	μA
		$V_{OUT} = 0V \text{ or } V_{CC}$					
V _{TH}	Differential Input High Threshold	V _{CM} = +1.2V				+100	mV
V _{⊤L}	Differential Input Low Threshold			-100			mV
IN	Input Current	V _{IN} = +2.4V, V _{CC} = 3.6	V			±10	μA
		$V_{IN} = 0V, V_{CC} = 3.6V$				±10	μA
TRANSI	MITTER SUPPLY CURRENT			•	,		
CCTW	Transmitter Supply Current	R _L = 100Ω,	f = 32.5 MHz		31	45	mA
		C _L = 5 pF,					
	Worst Case	Worst Case Pattern	f = 37.5 MHz		32	50	mA
		<i>(Figures 1, 3)</i> , T _A = −40°C to +85°C	f = 65 MHz		42	55	mA

	ecommended operating supply and	temperature rangee ameee e					
Symbol	Parameter	Conditio	ns	Min	Тур	Max	Units
TRANS	MITTER SUPPLY CURRENT						
ICCTG	Transmitter Supply Current	$R_{L} = 100\Omega,$ $C_{L} = 5 \text{ pF},$	f = 32.5 MHz		23	35	mA
	16 Grayscale	16 Grayscale Pattern	f = 37.5 MHz		28	40	mA
		<i>(Figures 2, 3)</i> , T _A = −40°C to +85°C	f = 65 MHz		31	45	mA
ICCTZ	Transmitter Supply Current	Power Down = Low	•		10	55	μA
	Power Down	Driver Outputs in TRI-S	TATE [®] under				
		Power Down Mode					
RECEIV	ER SUPPLY CURRENT						
ICCRW	Receiver Supply Current	C _ = 8 pF,	f = 32.5 MHz		49	65	mA
	Worst Case	Worst Case Pattern	f = 37.5 MHz		53	70	mA
		<i>(Figures 1, 4)</i> , T _A = −40°C to +85°C	f = 65 MHz		78	105	mA
ICCRG	Receiver Supply Current,	C _ = 8 pF,	f = 32.5 MHz		28	45	mA
	16 Grayscale	16 Grayscale Pattern	f = 37.5 MHz		30	47	mA
		<i>(Figures 2, 4)</i> , T _A = −40°C to +85°C	f = 65 MHz		43	60	mA
ICCRZ	Receiver Supply Current	Power Down = Low			10	55	μA
	Power Down	Receiver Outputs Stay L	ow during				
		Power Down Mode					

Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the device should be operated at these limits. The tables of "Electrical Characteristics" specify conditions for device operation.

Note 2: Typical values are given for V_{CC} = 3.3V and T_A = +25C.

Note 3: Current into device pins is defined as positive. Current out of device pins is defined as negative. Voltages are referenced to ground unless otherwise specified (except V_OD and $\Delta V_{OD}).$

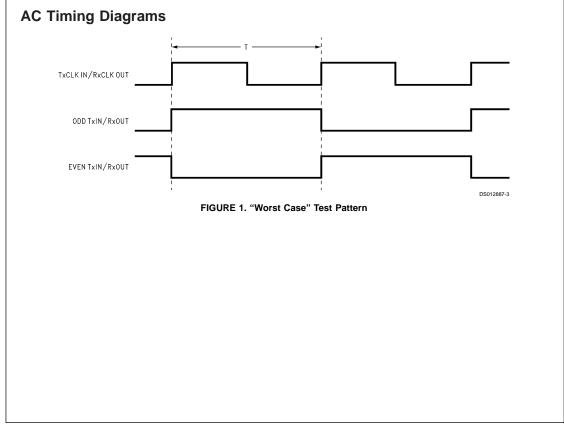
Note 4: V_{OS} previously referred as V_{CM} .

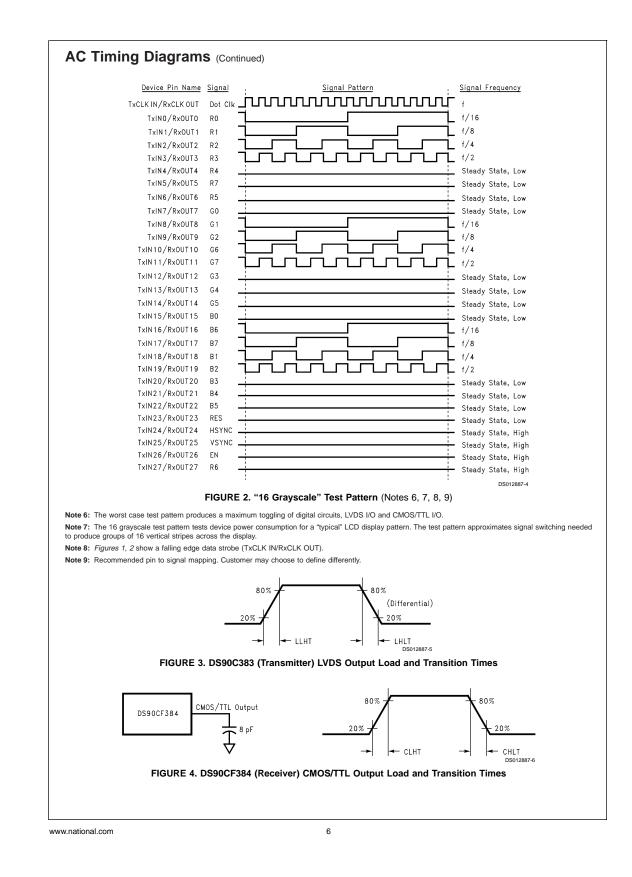
Transmitter Switching Characteristics Over recommended operating supply and -40°C to +85°C ranges unless otherwise specified

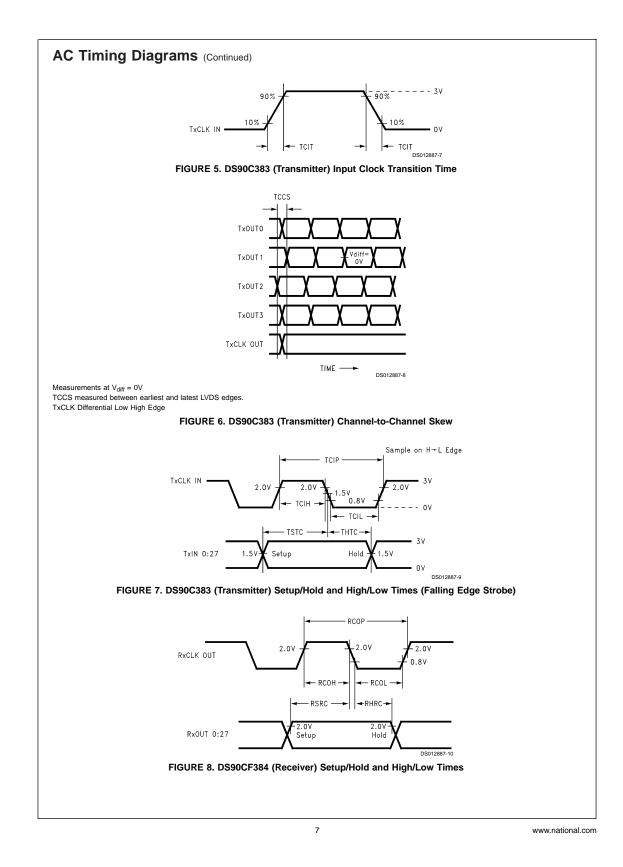
Symbol	Parameter		Min	Тур	Max	Units
LLHT	LVDS Low-to-High Transition Time (Figure 3)			0.75	1.5	ns
LHLT	LVDS High-to-Low Transition Time (Figure 3)			0.75	1.5	ns
TCIT	TxCLK IN Transition Time (Figure 5)				5	ns
TCCS	TxOUT Channel-to-Channel Skew (Figure 6)			250		ps
TPPos0	Transmitter Output Pulse Position for Bit 0 (Figure 17)	f = 65 MHz	-0.4	0	0.3	ns
TPPos1	Transmitter Output Pulse Position for Bit 1		1.8	2.2	2.5	ns
TPPos2	Transmitter Output Pulse Position for Bit 2		4.0	4.4	4.7	ns
TPPos3	Transmitter Output Pulse Position for Bit 3		6.2	6.6	6.9	ns
TPPos4	Transmitter Output Pulse Position for Bit 4		8.4	8.8	9.1	ns
TPPos5	Transmitter Output Pulse Position for Bit 5		10.6	11	11.3	ns
TPPos6	Transmitter Output Pulse Position for Bit 6		12.8	13.2	13.5	ns
TCIP	TxCLK IN Period (Figure 7)		15	Т	50	ns
TCIH	TxCLK IN High Time (Figure 7)		0.35T	0.5T	0.65T	ns
TCIL	TxCLK IN Low Time (Figure 7)		0.35T	0.5T	0.65T	ns
TSTC	TxIN Setup to TxCLK IN (Figure 7)	f = 65 MHz	2.5			ns
THTC	TxIN Hold to TxCLK IN (Figure 7)		0			ns
TCCD	TxCLK IN to TxCLK OUT Delay 25°C, V _{CC} = 3.3V (Figure 9)		3.0	3.7	5.5	ns
TPLLS	Transmitter Phase Lock Loop Set (Figure 11)				10	ms
TPDD	Transmitter Power Down Delay (Figure 15)				100	ns

Symbol	Parameter		Min	Тур	Max	Units
CLHT	CMOS/TTL Low-to-High Transition Time (Figure 4)			2.2	5.0	ns
CHLT	CMOS/TTL High-to-Low Transition Time (Figure 4)			2.2	5.0	ns
RSPos0	Receiver Input Strobe Position for Bit 0 (Figure 18)	f = 65 MHz	0.7	1.1	1.4	ns
RSPos1	Receiver Input Strobe Position for Bit 1		2.9	3.3	3.6	ns
RSPos2	Receiver Input Strobe Position for Bit 2		5.1	5.5	5.8	ns
RSPos3	Receiver Input Strobe Position for Bit 3		7.3	7.7	8.0	ns
RSPos4	Receiver Input Strobe Position for Bit 4		9.5	9.9	10.2	ns
RSPos5	Receiver Input Strobe Position for Bit 5		11.7	12.1	12.4	ns
RSPos6	Receiver Input Strobe Position for Bit 6		13.9	14.3	14.6	ns
RSKM	RxIN Skew Margin (Note 5) (Figure 19)	f = 65 MHz	400			ps
RCOP	RxCLK OUT Period (Figure 8)		15	Т	50	ns
RCOH	RxCLK OUT High Time (Figure 8)	f = 65 MHz	7.3	8.6		ns
RCOL	RxCLK OUT Low Time (Figure 8)		3.45	4.9		ns
RSRC	RxOUT Setup to RxCLK OUT (Figure 8)		2.5	6.9		ns
RHRC	RxOUT Hold to RxCLK OUT (Figure 8)		2.5	5.7		ns
RCCD	RxCLK IN to RxCLK OUT Delay 25°C, V_{CC} = 3.3V (Figure 10)	·	5.0	7.1	9.0	ns
RPLLS	Receiver Phase Lock Loop Set (Figure 12)				10	ms
RPDD	Receiver Power Down Delay (Figure 16)				1	μs

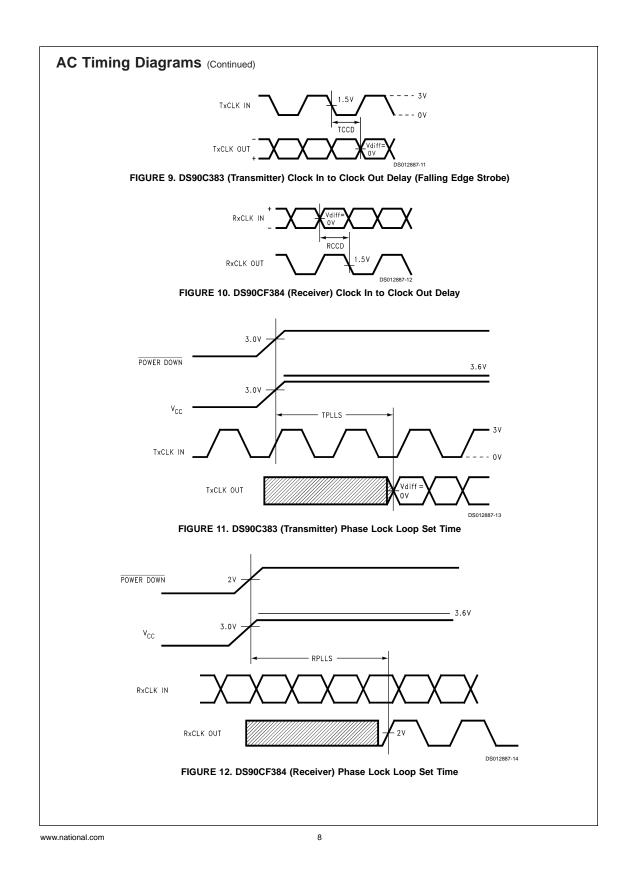
Note 5: Receiver Skew Margin is defined as the valid data sampling region at the receiver inputs. This margin takes into account the transmitter pulse positions (min and max) and the receiver input setup and hold time (internal data sampling window-RSPOS). This margin allows for LVDS interconnect skew, inter-symbol interference (both dependent on type/length of cable), and clock jitter (less than 250 ps).

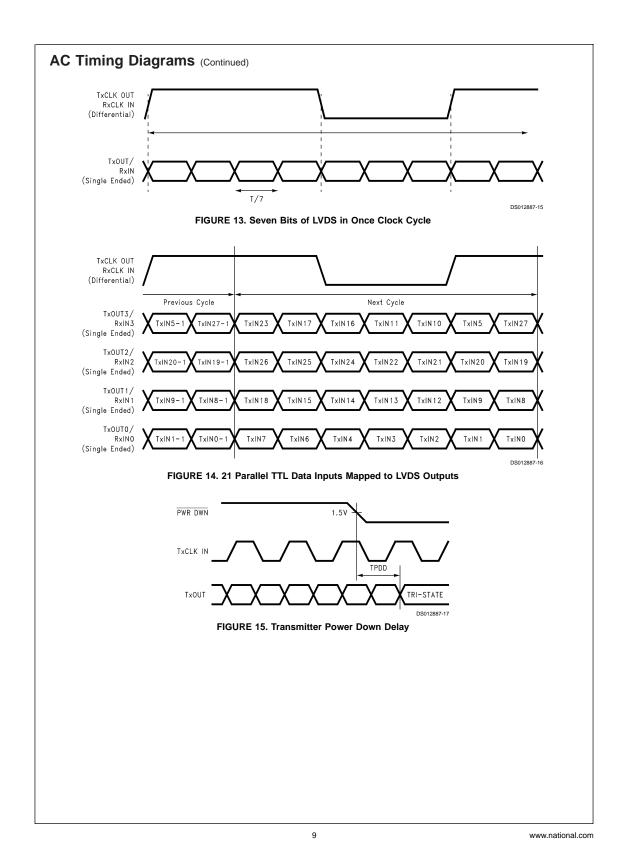


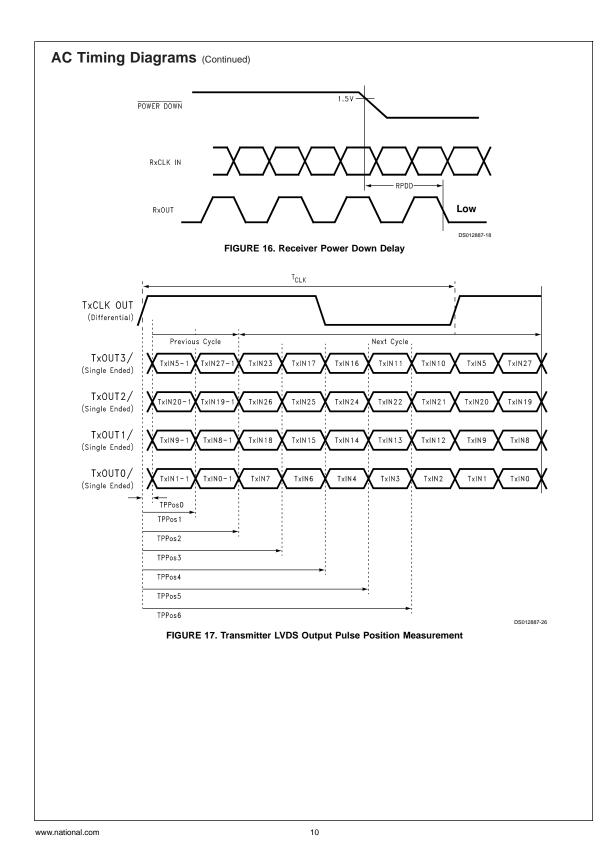


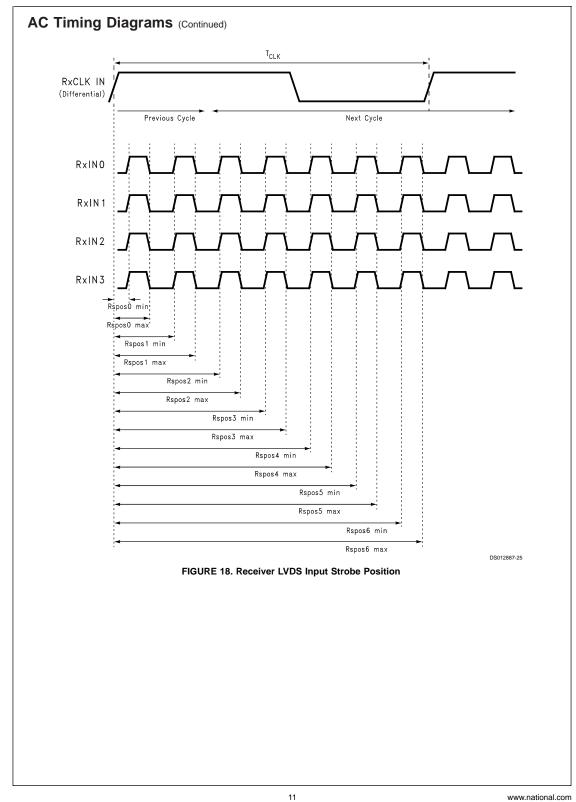


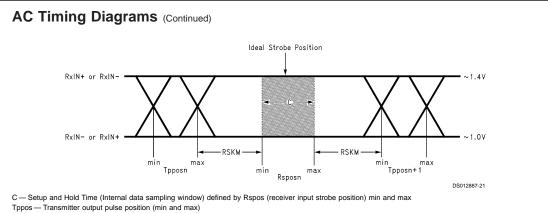
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RSKM = Cable Skew (type, length) + Source Clock Jitter (cycle to cycle) (Note 10) + ISI (Inter-symbol interference) (Note 11)

Cable Skew - typically 10 ps-40 ps per foot, media dependent

Note 10: Cycle-to-cycle jitter is less than 250 ps at 65 MHZ

Note 11: ISI is dependent on interconnect length; may be zero

FIGURE 19. Receiver LVDS Input Skew Margin

DS90C383 Pin Description—FPD Link Transmitter

Pin Name	I/O	No.	Description
TxIN	1	28	TTL level input. This includes: 8 Red, 8 Green, 8 Blue, and 4 control lines - FPLINE,
			FPFRAME and DRDY (also referred to as HSYNC, VSYNC, Data Enable).
TxOUT+	0	4	Positive LVDS differential data output.
TxOUT-	0	4	Negative LVDS differential data output.
FPSHIFT IN	1	1	TTL level clock input. The falling edge acts as data strobe. Pin name TxCLK IN.
R_FB	1	1	Programmable strobe select.
RTxCLK OUT+	0	1	Positive LVDS differential clock output.
TxCLK OUT-	0	1	Negative LVDS differential clock output.
PWR DOWN	1	1	TTL level input. When asserted (low input) TRI-STATES the outputs, ensuring low current at
			power down.
V _{CC}	1	3	Power supply pins for TTL inputs.
GND	1	4	Ground pins for TTL inputs.
PLL V _{CC}	I	1	Power supply pin for PLL.
PLL GND	I	2	Ground pins for PLL.
LVDS V _{CC}	I	1	Power supply pin for LVDS outputs.
LVDS GND		3	Ground pins for LVDS outputs.

Pin Name	I/O	No.	Description
RxIN+	1	4	Positive LVDS differential data inputs.
RxIN-	1	4	Negative LVDS differential data inputs.
RxOUT	0	28	TTL level data outputs. This includes: 8 Red, 8 Green, 8 Blue, and 4 control lines—FPLINE FPFRAME, DRDY (also referred to as HSYNC, VSYNC, Data Enable).
RxCLK IN+	1	1	Positive LVDS differential clock input.
RxCLK IN-	1	1	Negative LVDS differential clock input.
FPSHIFT OUT	0	1	TTL level clock output. The falling edge acts as data strobe. Pin name RxCLK OUT.
PWR DOWN	1	1	TTL level input. When asserted (low input) the receiver outputs are low.
V _{CC}	I	4	Power supply pins for TTL outputs.
GND	Ι	5	Ground pins for TTL outputs.
PLL V_{CC}	1	1	Power supply for PLL.
PLL GND	I	2	Ground pin for PLL.
LVDS V _{CC}	Ι	1	Power supply pin for LVDS inputs.
LVDS GND		3	Ground pins for LVDS inputs.

DS90CF384 64 ball FBGA package Pin Description—FPD Link Receiver

Pin Name	I/O	No.	Description
RxIN+	1	4	Positive LVDS differential data inputs.
RxIN-	I	4	Negative LVDS differential data inputs.
RxOUT	0	28	TTL level data outputs. This includes: 8 Red, 8 Green, 8 Blue, and 4 control lines — FPLINE, FPFRAME, DRDY (also referred to as HSYNC, VSYNC, Data Enable).
RxCLK IN+	I	1	Positive LVDS differential clock input.
RxCLK IN-	I	1	Negative LVDS differential clock input.
FPSHIFT OUT	0	1	TTL level clock output. The falling edge acts as data strobe. Pin name RxCLK OUT.
PWR DOWN	I	1	TTL level input. When asserted (low input) the receiver outputs are low.
V _{cc}	I	4	Power supply pins for TTL outputs.
GND	I	5	Ground pins for TTL outputs.
PLL V _{CC}	I	1	Power supply for PLL.
PLL GND	I	2	Ground pin for PLL.
LVDS V _{CC}	I	1	Power supply pin for LVDS inputs.
LVDS GND	I	3	Ground pins for LVDS inputs.
NC		6	Pins not connected.

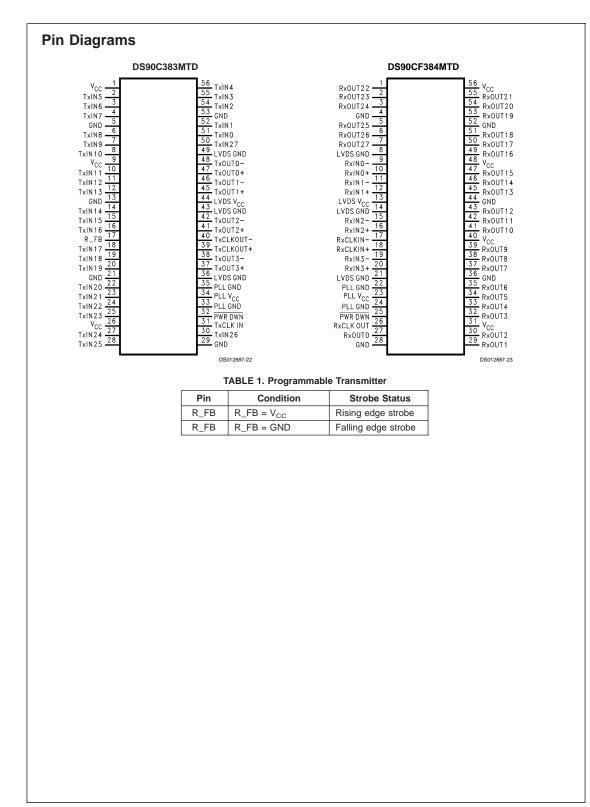
Applications Information

The DS90C383 and DS90CF384 are backward compatible with the existing 5V FPD Link transmitter/receiver pair (DS90CR583, DS90CR584, DS90CF583 and DS90CF584). To upgrade from a 5V to a 3.3V system the following must be addressed:

- 1. Change 5V power supply to 3.3V. Provide this supply to the V_{CC}, LVDS V_{CC} and PLL V_{CC} of both the transmitter and receiver devices. This change may enable the removal of a 5V supply from the system, and power may be supplied from an existing 3V power source.
- 2. The DS90C383 (transmitter) incorporates a rise/fall strobe select pin. This select function is on pin 17, formerly a V_{CC} connection on the 5V products. When the rise/fall strobe select pin is connected to V_{CC}, the part is configured with a rising edge strobe. In a system currently using a 5V rising edge strobe transmitter (DS90CR583), no layout changes are required to accommodate the new rise/fall select pin on the 3.3V transmitter. The V_{CC} signal may remain at pin 17, and the device will be configured with a rising edge strobe.

When converting from a 5V falling edge transmitter (DS90CF583) to the 3V transmitter a minimal board layout change is necessary. The 3.3V transmitter will not be configured with a falling edge strobe if V_{CC} remains connected to the select pin. To guarantee the 3.3V transmitter functions with a falling edge strobe pin 17 should be connected to ground OR left unconnected. When not connected (left open) and internal pull-down resistor ties pin 17 to ground, thus configuring the transmitter with a falling edge strobe.

 The DS90C383 transmitter input and control inputs accept 3.3V TTL/CMOS levels. They are not 5V tolerant.



	By Pin			By Pin Type	
Pin	Pin Name	Туре	Pin	Pin Name	Туре
\ 1	RxOUT17	0	A4	GND	G
12	VCC	Р	B1	GND	G
43	RxOUT15	0	B6	GND	G
\4	GND	G	D8	GND	G
۹5	RxOUT12	0	E3	GND	G
۹6	RxOUT8	0	E5	LVDS GND	G
\7	RxOUT7	0	G3	LVDS GND	G
48	RxOUT6	0	G7	LVDS GND	G
31	GND	G	H5	LVDS GND	G
32	NC		F6	PLL GND	G
33	RxOUT16	0	G8	PLL GND	G
34	RxOUT11	0	E6	PWR DWN	
35	VCC	P	H6	RxCLKIN-	1
36	GND	G	H7	RxCLKIN+	1
37	RxOUT5	0	H2	RxIN0-	1
38	RxOUT3	0	H3	RxIN0+	
C1	RxOUT21	0	F4	RxIN1-	
02	NC	-	G4	RxIN1+	
02	RxOUT18	0	G5	RxIN2-	· ·
C4	RxOUT14	0	F5	RxIN2+	· ·
25	RxOUT9	0	G6	RxIN3-	· ·
26	RxOUT4	0	H8	RxIN3+	
27	NC	0	E7	RxCLKOUT	0
28	RxOUT1	0	E8	RXOUTO	0
D1	VCC	P	C8	RxOUT1	0
02	RxOUT20	0	D5	RxOUT10	0
03	RxOUT19	0	B4	RxOUT11	0
)4	RxOUT13	0	A5	RxOUT12	0
)4)5	RxOUT10	0	D4	RxOUT12 RxOUT13	0
D6	VCC	0	C4	RxOUT13	0
			-		0
07 08	RxOUT2 GND	O G	A3 B3	RxOUT15 RxOUT16	0
58 E1					
	RxOUT22	0	A1	RxOUT17	0
2	RxOUT24	0	C3	RxOUT18	0
3	GND	G	D3	RxOUT19	0
E4		P	D7	RxOUT2	0
5	LVDS GND	G	D2	RxOUT20	0
E6	PWR DWN	1	C1	RxOUT21	0
7	RxCLKOUT	0	E1	RxOUT22	0
8	RxOUT0	0	F1	RxOUT23	0
-1	RxOUT23	0	E2	RxOUT24	0
-2	RxOUT26	0	G1	RxOUT25	0
-3	NC		F2	RxOUT26	0
-4	RxIN1-	I	H1	RxOUT27	0
5	RxIN2+	I	B8	RxOUT3	0
6	PLL GND	G	C6	RxOUT4	0
7	PLL VCC	Р	B7	RxOUT5	0
-8	NC		A8	RxOUT6	0

	By Pin			By Pin Type	
G1	RxOUT25	0	A7	RxOUT7	0
G2	NC		A6	RxOUT8	0
33	LVDS GND	G	C5	RxOUT9	0
G4	RxIN1+	I	E4	LVDS VCC	Р
3 5	RxIN2-	I	H4	LVDS VCC	Р
G6	RxIN3-	I	F7	PLL VCC	Р
G7	LVDS GND	G	A2	VCC	Р
3 8	PLL GND	G	B5	VCC	Р
-11	RxOUT27	0	D1	VCC	Р
12	RxIN0-	I	D6	VCC	Р
-13	RxIN0+	I	B2	NC	
-14	LVDS VCC	Р	C2	NC	
15	LVDS GND	G	C7	NC	
16	RxCLKIN-	I	F3	NC	
17	RxCLKIN+	I	F8	NC	
-18	RxIN3+	I	G2	NC	

